MOSFET – N-Channel, SUPERFET[®] II

600 V, 52 A, 72 m Ω

FCH072N60

Description

SUPERFET II MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET is suitable for various AC/DC power conversion for system miniaturization and higher efficiency.

Features

- Typ. $R_{DS(on)} = 66 \text{ m}\Omega$
- $650 \text{ V} @ \text{T}_{\text{J}} = 150^{\circ}\text{C}$
- Ultra Low Gate Charge (Typ. Q_g = 95 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 421 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

Applications

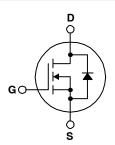
- Telecom / Sever Power Supplies
- Industrial Power Supplies



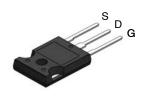
ON Semiconductor®

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V _{DS}	R _{DS(ON)} MAX	I _D MAX
600 V	72 mΩ @ 10 V	52 A

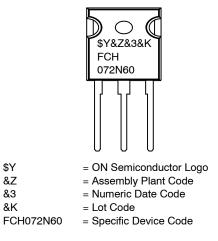


N-CHANNEL MOSFET



TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Paramete	er	FCH072N60	Unit	
V _{DSS}	Drain to Source Voltage		600	V	
V _{GSS}	Gate to Source Voltage	– DC	±20	V	
		– AC (f > 1 Hz)	±30		
I _D	Drain Current:	– Continuous (T _C = 25°C)	52	A	
		– Continuous (T _C = 100°C)	33	A	
I _{DM}	I _{DM} Drain Current: – Pulsed (Note 1)	– Pulsed (Note 1)	156	A	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	3 , (),		mJ	
I _{AR}	Avalanche Current (Note 1)			A	
E _{AR}	Repetitive Avalanche Energy (Note 1)	/ (Note 1)	4.8	mJ	
dv/dt	MOSFET dv/dt	IOSFET dv/dt		V/ns	
	Peak Diode Recovery dv/dt (Note 3)		20		
PD	Power Dissipation	(T _C = 25°C)	481	W	
		– Derate Above 25°C	3.85	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range	9	–55 to + 150	°C	
ΤL	Maximum Lead Temperature for Soldering,	, 1/8" from Case for 5 seconds	300	°C	

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality shows be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 9.5 \text{ A}, R_G = 25 \Omega$, Starting $T_J = 25 \text{ °C}$. 3. $I_{SD} \le 26 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, \text{V}_{DD} \le 380 \text{ V}$, Starting $T_J = 25 \text{ °C}$.

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
FCH072N60	FCH072N60	TO-247	Tube	N/A	N/A	30 Units

THERMAL CHARACTERISTICS

Symbol	Parameter	Parameter FCH072N60	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.26	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
FF CHARA	ACTERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	I_D = 10 mA, V_{GS} = 0 V, T_J = 25°C	600	-	-	V
		I_D = 10 mA, V_{GS} = 0 V, T_J = 150°C	650	-	-	
$\begin{array}{c} \Delta \text{BV}_{\text{DSS}} \\ /\Delta T_{\text{J}} \end{array}$	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, Referenced to $25^{\circ}C$	_	0.67	_	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μA
		V_{DS} = 480 V, V_{GS} = 0 V, T_{C} = 125 $^{\circ}C$	-	4.1	-	
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20$ V, $V_{DS} = 0$ V	-	-	±100	nA

V _{GS(th)}	Gate Threshold Voltage	$V_{GS}=V_{DS},I_{D}=250\;\mu A$	2.5	-	3.5	V
R _{DS(on)}	Static Drain to Source On Resistance	V_{GS} = 10 V, I _D = 26 A	_	66	72	mΩ
9 _{FS}	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 26 \text{ A}$	_	48	_	S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	$V_{DS} = 380 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	4430	5890	pF
C _{oss}	Output Capacitance		-	115	155	pF
C _{rss}	Reverse Transfer Capacitance		-	4.43	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 480 V, V_{GS} = 0 V	-	421	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 380 \text{ V}, \text{ I}_{D} = 26 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	-	95	125	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	-	21	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	24	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	0.93	-	Ω

SWITCHING CHARACTERISTICS

t _{d(on)}	Turn-On Delay Time	$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 26 \text{ A},$	-	33	76	ns
t _r	Turn-On Rise Time	V _{GS} = 10 V, R _g = 4.7 Ω (Note 4)	_	23	56	ns
t _{d(off)}	Turn-Off Delay Time		_	97	204	ns
t _f	Turn-Off Fall Time		-	3.5	17	ns

DRAIN-SOURCE DIODE CHARACTERISTICS

۱ _S	Maximum Continuous Source to Drain Diode Forward Current		-	-	52	A
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	156	А
V _{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 26 \text{ A}$	-	-	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 26 A, dI _F /dt = 100 A/µs	-	495	-	ns
Q _{rr}	Reverse Recovery Charge		-	13	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature.

TYPICAL CHARACTERISTICS

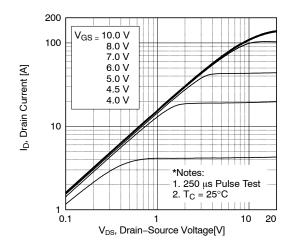


Figure 1. On-Region Characteristics

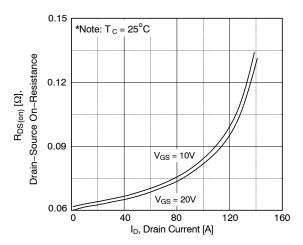


Figure 3. On–Resistance Variation vs. Drain Current and Gate Voltage

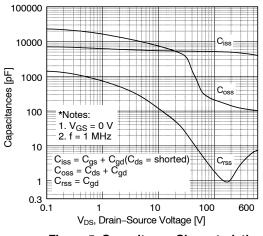


Figure 5. Capacitance Characteristics

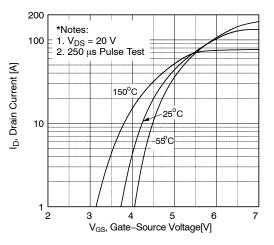


Figure 2. Transfer Characteristics

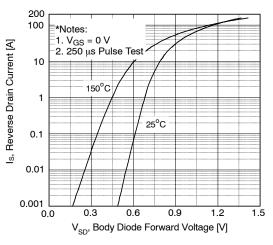
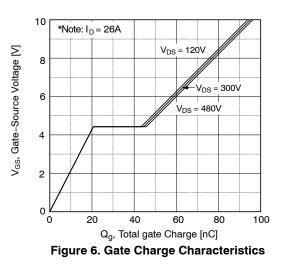


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature



TYPICAL CHARACTERISTICS

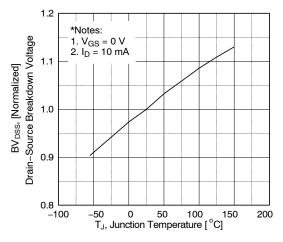


Figure 7. Breakdown Voltage Variation vs. Temperature

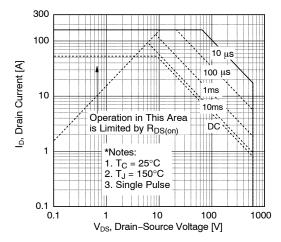


Figure 9. Maximum Safe Operating Area

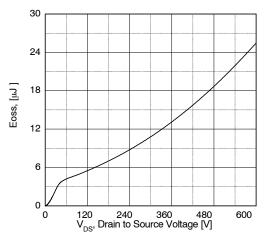


Figure 11. Eoss vs. Drain to Source Voltage

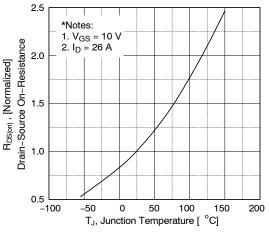


Figure 8. On–Resistance Variation vs. Temperature

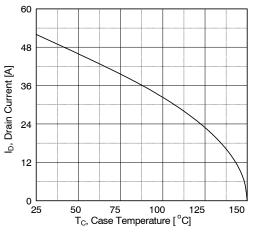
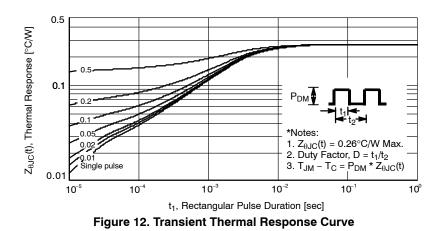
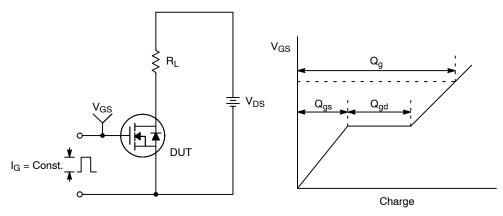


Figure 10. Maximum Drain Current vs. Case Temperature

TYPICAL CHARACTERISTICS







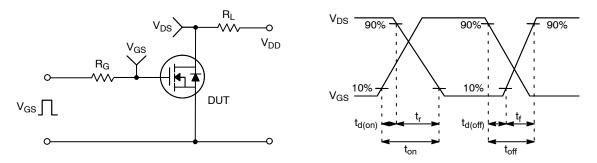


Figure 14. Resistive Switching Test Circuit & Waveforms

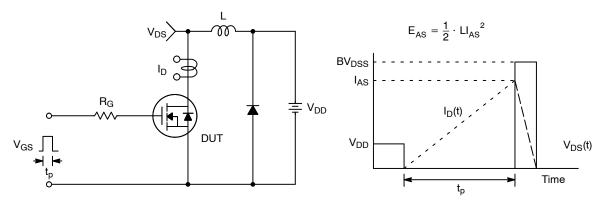


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

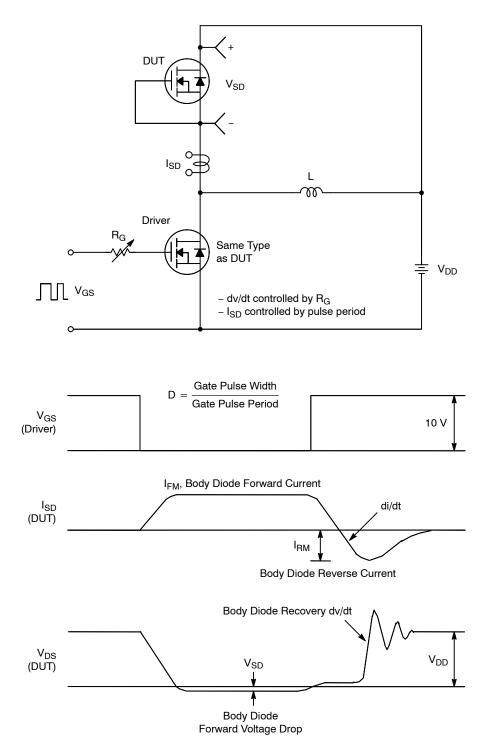
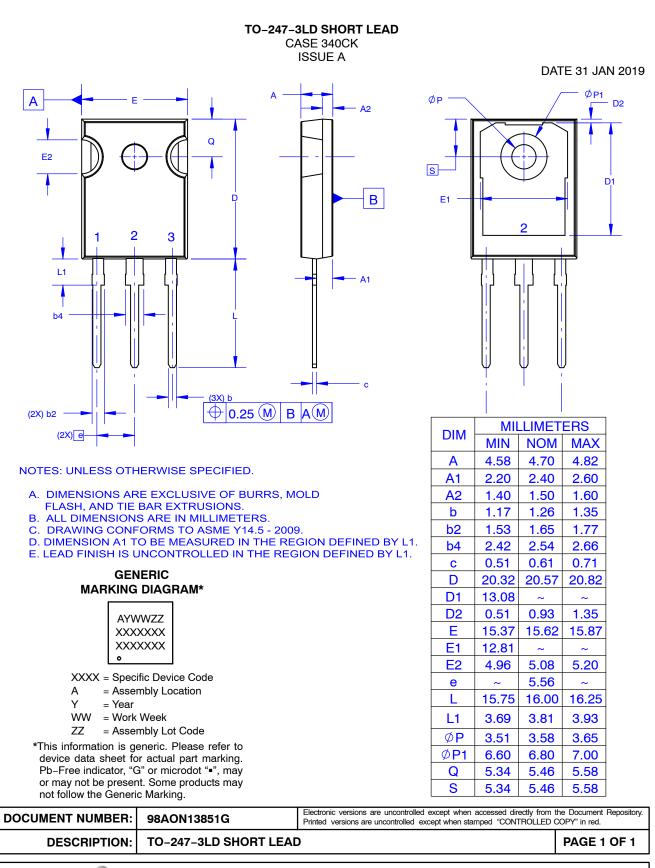


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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